

Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from, Europe, America and south Asia, supplying obsolete and hard-to-find components to meet their specific needs.

With the principle of "Quality Parts, Customers Priority, Honest Operation, and Considerate Service", our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip, ALPS, ROHM, Xilinx, Pulse, ON, Everlight and Freescale. Main products comprise IC, Modules, Potentiometer, IC Socket, Relay, Connector. Our parts cover such applications as commercial, industrial, and automotives areas.

We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!



Contact us

Tel: +86-755-8981 8866 Fax: +86-755-8427 6832

Email & Skype: info@chipsmall.com Web: www.chipsmall.com

Address: A1208, Overseas Decoration Building, #122 Zhenhua RD., Futian, Shenzhen, China









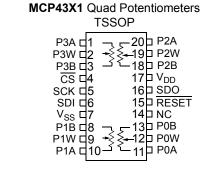
MCP433X/435X

7/8-Bit Quad SPI Digital POT with Volatile Memory

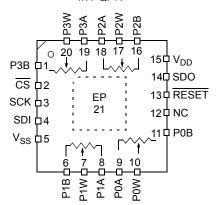
Features

- · Quad Resistor Network
- · Potentiometer or Rheostat Configuration Options
- · Resistor Network Resolution:
 - 7-bit: 128 Resistors (129 Taps)
 - 8-bit: 256 Resistors (257 Taps)
- · RAB Resistances Options of:
 - 5 kΩ
 - $10 \text{ k}\Omega$
 - 50 kΩ
 - 100 kΩ
- · Zero Scale to Full Scale Wiper Operation
- Low Wiper Resistance: 75 Ω (typical)
- · Low Tempco:
 - Absolute (Rheostat): 50 ppm typical (0°C to 70°C)
 - Ratiometric (Potentiometer): 15 ppm typical
- SPI Serial Interface (10 MHz, Modes 0,0 and 1,1):
 - High-Speed Read/Writes to wiper registers
- Resistor Network Terminal Disconnect Feature via Terminal Control (TCON) Register
- · Reset Input Pin
- Brown-out Reset Protection (1.5V typical)
- Serial Interface Inactive Current (2.5 µA typical)
- High-Voltage Tolerant Digital Inputs: Up to 12.5V
- · Supports Split Rail Applications
- · Internal Weak Pull-up on all Digital Inputs
- · Wide Operating Voltage:
 - 2.7V to 5.5V Device Characteristics Specified
 - 1.8V to 5.5V Device Operation
- · Wide Bandwidth (-3 dB) Operation:
 - 2 MHz (typical) for 5.0 k Ω device
- Extended Temperature Range (-40°C to +125°C)

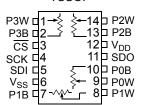
Package Types (Top View)



MCP43X1 Quad Potentiometers 4x4 QFN*

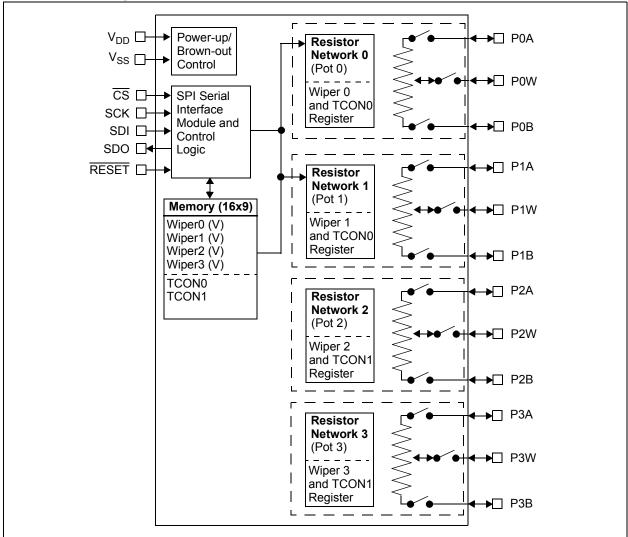


MCP43X2 Quad Rheostat TSSOP



* Includes Exposed Thermal Pad (EP); see Table 3-1.

Device Block Diagram



Device Features

	OTs		_ 0	>	ock logy	oer g	Resistance (typic	cal)	SC	V	
Device	# of PO	Wiper Configuration	Control Interface	Memory Type	WiperLock Technology	POR Wiper Setting	R _{AB} Options (kΩ)	Wiper - R _W (Ω)	# of Taps	V _{DD} Operating Range ⁽²⁾	
MCP4331	4	Potentiometer (1)	SPI	RAM	No	Mid-Scale	5.0, 10.0, 50.0, 100.0	75	129	1.8V to 5.5V	
MCP4332	4	Rheostat	SPI	RAM	No	Mid-Scale	5.0, 10.0, 50.0, 100.0	75	129	1.8V to 5.5V	
MCP4341	4	Potentiometer (1)	SPI	EE	Yes	NV Wiper	5.0, 10.0, 50.0, 100.0	75	129	2.7V to 5.5V	
MCP4342	4	Rheostat	SPI	EE	Yes	NV Wiper	5.0, 10.0, 50.0, 100.0	75	129	2.7V to 5.5V	
MCP4351	4	Potentiometer (1)	SPI	RAM	No	Mid-Scale	5.0, 10.0, 50.0, 100.0	75	257	1.8V to 5.5V	
MCP4352	4	Rheostat	SPI	RAM	No	Mid-Scale	5.0, 10.0, 50.0, 100.0	75	257	1.8V to 5.5V	
MCP4361	4	Potentiometer (1)	SPI	EE	Yes	NV Wiper	5.0, 10.0, 50.0, 100.0	75	257	2.7V to 5.5V	
MCP4362	4	Rheostat	SPI	EE	Yes	NV Wiper	5.0, 10.0, 50.0, 100.0	75	257	2.7V to 5.5V	

Note 1: Floating either terminal (A or B) allows the device to be used as a Rheostat (variable resistor).

^{2:} Analog characteristics only tested from 2.7V to 5.5V unless otherwise noted.

1.0 ELECTRICAL CHARACTERISTICS

Absolute Maximum Ratings †

Voltage on V_{DD} with respect to V_{SS} 0.6V to +7.0V Voltage on \overline{CS} , SCK, SDI, SDI/SDO, and \overline{RESET} with respect to V_{SS} 0.6V to 12.5V Voltage on all other pins (PxA, PxW, PxB and SDO) with respect to V_{SS} 0.3V to V_{DD} + 0.3V Input clamp current, I_{IK}
$(V_I < 0, V_I > V_{DD}, V_I > V_{PP} \text{ on HV pins})\pm 20 \text{ mA}$ Output clamp current, I_{OK}
$(V_O < 0 \text{ or } V_O > V_{DD})$ ±20 mA
Maximum output current sunk by any Output pin
25 mA
Maximum output current sourced by any Output pin
Maximum current out of V _{SS} pin100 mA
Maximum current into V _{DD} pin100 mA
Maximum current into PxA, PxW and PxB pins
±2.5 mA Storage temperature65°C to +150°C Ambient temperature with power applied
-40°C to +125°C
Package power dissipation
(T _A = +50°C, T _J = +150°C) TSSOP-14 1000 mW
TSSOP-201110 mW
QFN-20 (4x4)
Soldering temperature of leads
(10 seconds)+300°C
ESD protection on all pins≥ 4 kV (HBM),
≥ 300V (MM)
Maximum Junction Temperature (T _J)+150°C

† Notice: Stresses above those listed under "Maximum Ratings" may cause permanent damage to the device. This is a stress rating only and functional operation of the device at those or any other conditions above those indicated in the operational listings of this specification is not implied. Exposure to maximum rating conditions for extended periods may affect device reliability.

AC/DC CHARACTERISTICS

		Standard Operating Conditions (unless otherwise specified) Operating Temperature $-40^{\circ}\text{C} \le \text{T}_{\text{A}} \le +125^{\circ}\text{C}$ (extended)									
DC Characteristics	3	All parameters apply across the specified operating ranges unless noted. V_{DD} = +2.7V to 5.5V, 5 k Ω , 10 k Ω , 50 k Ω , 100 k Ω devices. Typical specifications represent values for V_{DD} = 5.5V, T_A = +25°C.									
Parameters	Sym	Min	Тур	Max	Units	Conditions					
Supply Voltage	V_{DD}	2.7	_	5.5	V						
		1.8	_	2.7	V	Serial Interfa	ace only.				
CS, SDI, SDO,	V_{HV}	V_{SS}	_	12.5V	V	$V_{DD} \geq 4.5 V$	The CS pin will be at one				
SCK, RESET pin Voltage Range		V _{SS}	_	V _{DD} + 8.0V	V	V _{DD} < 4.5V	of three input levels (V _{IL} , V _{IH} or V _{IHH}). (Note 6)				
V _{DD} Start Voltage to ensure Wiper Reset	V _{BOR}	_	_	1.65	٧	RAM retention voltage (V _{RAM}) < V _{BOR}					
V _{DD} Rise Rate to ensure Power-on Reset	V_{DDRR}		(Note 9)		V/ms						
Delay after device exits the Reset state (V _{DD} > V _{BOR})	T _{BORD}	_	10	20	μs						
Supply Current (Note 10)	I _{DD}	_	_	450	μΑ	Serial Interface Active, V _{DD} = 5.5V, $\overline{\text{CS}}$ = V _{IL} , SCK @ 5 MHz, write all 0's to volatile Wiper 0 (address 0h)					
		_	2.5	5	μA	Serial Interface Inactive, CS = V _{IH} , V _{DD} = 5.5V					
		_	0.55	1	mA	Serial Interfa V _{DD} = 5.5V, SCK @ 5 M decrement v (address 0h	CS = V _{IHH} , Hz, volatile Wiper 0				

- Note 1: Resistance is defined as the resistance between terminal A to terminal B.
 - 2: INL and DNL are measured at V_W with $V_A = V_{DD}$ and $V_B = V_{SS}$.
 - 3: MCP43X1 only.
 - 4: MCP43X2 only, includes V_{WZSE} and V_{WFSE} .
 - 5: Resistor terminals A, W and B's polarity with respect to each other is not restricted.
 - 6: This specification by design.
 - 7: Non-linearity is affected by wiper resistance (R_W), which changes significantly over voltage and temperature.
 - 8: The MCP43X1 is externally connected to match the configurations of the MCP43X2, and then tested.
 - 9: POR/BOR is not rate dependent.
 - **10:** Supply current is independent of current through the resistor network.

DC Characteristic	Operating Temperature $-40^{\circ}\text{C} \leq \text{T}_{\text{A}} \leq +125^{\circ}\text{C}$ (extended) All parameters apply across the specified operating ranges unless noted. $V_{\text{DD}} = +2.7\text{V}$ to 5.5V, 5 k Ω , 10 k Ω , 50 k Ω , 100 k Ω devices. Typical specifications represent values for $V_{\text{DD}} = 5.5\text{V}$, $T_{\text{A}} = +25^{\circ}\text{C}$.									
Parameters	Sym	Min	Тур	Max	Units	Conditions				
Resistance	R _{AB}	4.0	5	6.0	kΩ	-502 devices (Note 1)				
(± 20%)		8.0	10	12.0	kΩ	-103 device	s (Note 1)			
		40.0	50	60.0	kΩ	-503 device	s (Note 1)			
		80.0	100	120.0	kΩ	-104 device	s (Note 1)			
Resolution	N		257		Taps	8-bit	No Missing Codes			
			129		Taps	7-bit	No Missing Codes			
Step Resistance	R_S	_	R _{AB} / (256)	_	Ω	8-bit	Note 6			
		_	R _{AB} / (128)	_	Ω	7-bit	Note 6			
Nominal	(R _{ABWC} -	_	0.2	1.50	%	5 kΩ	MCP43X1 devices only			
Resistance Match	R _{ABMEAN})/	_	0.2	1.25	%	10 kΩ				
	R_{ABMEAN}	1	0.2	1.0	%	50 kΩ				
			0.2	1.0	%	100 kΩ				
	(R _{BWWC} -	-	0.25	1.75	%	5 kΩ	Code = Full Scale			
	R _{BWMEAN})/ R _{BWMEAN}	-	0.25	1.50	%	10 kΩ				
		_	0.25	1.25	%	50 kΩ				
		_	0.25	1.25	%	100 kΩ				
Wiper Resistance	R_W	_	75	160	Ω	V _{DD} = 5.5 V	, I _W = 2.0 mA, code = 00h			
(Note 3, Note 4)		_	75	300	Ω	$V_{DD} = 2.7 \text{ V}$, I _W = 2.0 mA, code = 00h			
Nominal	ΔR _{AB} /ΔT	_	50	_	ppm/°C	$T_A = -20^{\circ}C$	to +70°C			
Resistance		_	100	_	ppm/°C	$T_A = -40^{\circ}C \text{ to } +85^{\circ}C$				
Tempco		_	150	_	ppm/°C	$T_A = -40^{\circ}C \text{ to } +125^{\circ}C$				
Ratiometeric Tempco	$\Delta V_{WB}/\Delta T$	1	15	1	ppm/°C	Code = Mid-scale (80h or 40h)				
Resistance Tracking	ΔR _{TRACK}	S	Section 2.	0	ppm/°C	See Section Curves"	n 2.0 "Typical Performance			

Standard Operating Conditions (unless otherwise specified)

- Note 1: Resistance is defined as the resistance between terminal A to terminal B.
 - 2: INL and DNL are measured at V_W with $V_A = V_{DD}$ and $V_B = V_{SS}$.
 - 3: MCP43X1 only.
 - 4: MCP43X2 only, includes V_{WZSE} and V_{WFSE} .
 - 5: Resistor terminals A, W and B's polarity with respect to each other is not restricted.
 - **6:** This specification by design.
 - **7:** Non-linearity is affected by wiper resistance (R_W), which changes significantly over voltage and temperature.
 - 8: The MCP43X1 is externally connected to match the configurations of the MCP43X2, and then tested.
 - **9:** POR/BOR is not rate dependent.
 - **10:** Supply current is independent of current through the resistor network.

DC Characteristics	3	Standard Operating Conditions (unless otherwise specified) Operating Temperature $-40^{\circ}\text{C} \leq \text{T}_{\text{A}} \leq +125^{\circ}\text{C} \text{ (extended)}$ All parameters apply across the specified operating ranges unless noted. $V_{DD} = +2.7V \text{ to } 5.5V, 5 \text{ k}\Omega, 10 \text{ k}\Omega, 50 \text{ k}\Omega, 100 \text{ k}\Omega \text{ devices.}$ Typical specifications represent values for $V_{DD} = 5.5V, T_{\text{A}} = +25^{\circ}\text{C}.$								
Parameters	Sym	Min	Тур	Max	Max Units Conditions					
Resistor Terminal Input Voltage Range (Terminals A, B and W)	$V_{A,}V_{W,}V_{B}$	Vss	_	V _{DD}	V	Note 5, Note 6				
Maximum current through A, W or B	I _W			2.5	mA	Worst case current through wiper when wiper is either Full Scale or Zero Scale. (Note 6)				
Leakage current	I _{WL}	_	100	1	nA	MCP43X1 PxA = PxW = PxB = V _{SS}				
into A, W or B		_	100	_	nA	MCP43X2 PxB = PxW = V _{SS}				

- Note 1: Resistance is defined as the resistance between terminal A to terminal B.
 - 2: INL and DNL are measured at V_W with $V_A = V_{DD}$ and $V_B = V_{SS}$.
 - 3: MCP43X1 only.
 - 4: MCP43X2 only, includes V_{WZSE} and V_{WFSE} .
 - **5:** Resistor terminals A, W and B's polarity with respect to each other is not restricted.
 - **6:** This specification by design.
 - 7: Non-linearity is affected by wiper resistance (R_W), which changes significantly over voltage and temperature.
 - 8: The MCP43X1 is externally connected to match the configurations of the MCP43X2, and then tested.
 - **9:** POR/BOR is not rate dependent.
 - **10:** Supply current is independent of current through the resistor network.

 $3.0 \text{V} \le \text{V}_{DD} \le 5.5 \text{V}$ MCP43X1 devices only

 $3.0 \text{V} \le \text{V}_{DD} \le 5.5 \text{V}$ MCP43X1 devices only

8-bit | Code = 80h

7-bit | Code = 40h

8-bit | Code = 80h

Code = 80h

Code = 40h

Code = 40h

Code = 80h

Code = 40h

(Note 2)

(Note 2)

8-bit

7-bit

7-bit

8-bit

7-bit

AC/DC CHARACTERISTICS (CONTINUED)

			Operating Temperature $-40^{\circ}\text{C} \le T_{A} \le +125^{\circ}\text{C} \text{ (extended)}$									
DC Characteristics	All parameters apply across the specified operating ranges unless noted. V_{DD} = +2.7V to 5.5V, 5 k Ω , 10 k Ω , 50 k Ω , 100 k Ω devices. Typical specifications represent values for V_{DD} = 5.5V, T_A = +25°C.											
Parameters	Sym	Min	Тур	Max	Units		Conditions					
Full Scale Error	V _{WFSE}	-6.0	-0.1	1	LSb	5 kΩ	8-bit	$3.0V \leq V_{DD} \leq 5.5V$				
(MCP43X1 only)		-4.0	-0.1		LSb		7-bit	$3.0V \leq V_{DD} \leq 5.5V$				
(8-bit code = 100h, 7-bit code = 80h)		-3.5	-0.1		LSb	10 kΩ	8-bit	$3.0V \leq V_{DD} \leq 5.5V$				
		-2.0	-0.1		LSb		7-bit	$3.0V \leq V_{DD} \leq 5.5V$				
		-0.8	-0.1	_	LSb	50 kΩ	8-bit	$3.0V \leq V_{DD} \leq 5.5V$				
		-0.5	-0.1	_	LSb		7-bit	$3.0V \leq V_{DD} \leq 5.5V$				
		-0.5	-0.1	_	LSb	100 kΩ	8-bit	$3.0V \leq V_{DD} \leq 5.5V$				
		-0.5	-0.1	_	LSb		7-bit	$3.0V \leq V_{DD} \leq 5.5V$				
Zero Scale Error	V_{WZSE}	_	+0.1	+6.0	LSb	5 kΩ	8-bit	$3.0V \leq V_{DD} \leq 5.5V$				
(MCP43X1 only)		_	+0.1	+3.0	LSb		7-bit	$3.0V \leq V_{DD} \leq 5.5V$				
(8-bit code = 00h, 7-bit code = 00h)		_	+0.1	+3.5	LSb	10 kΩ	8-bit	$3.0V \leq V_{DD} \leq 5.5V$				
		_	+0.1	+2.0	LSb		7-bit	$3.0V \leq V_{DD} \leq 5.5V$				
		_	+0.1	+0.8	LSb	50 kΩ	8-bit	$3.0V \leq V_{DD} \leq 5.5V$				
		_	+0.1	+0.5	LSb		7-bit	$3.0V \leq V_{DD} \leq 5.5V$				
		_	+0.1	+0.5	LSb	100 kΩ	8-bit	$3.0V \leq V_{DD} \leq 5.5V$				
		_	+0.1	+0.5	LSb		7-bit	$3.0V \leq V_{DD} \leq 5.5V$				

Standard Operating Conditions (unless otherwise specified)

- Note 1: Resistance is defined as the resistance between terminal A to terminal B.
 - 2: INL and DNL are measured at V_W with $V_A = V_{DD}$ and $V_B = V_{SS}$.

-1

-0.5

-0.5

-0.25

±0.5

±0.25

±0.25

±0.125

2

2

1

1

200

200

100

100

+1

+0.5

+0.5

+0.25

LSb

LSb

LSb

LSb

MHz

MHz

MHz

MHz

kHz

kHz

kHz

kHz

8-bit

7-bit

8-bit

7-bit

 $5~\text{k}\Omega$

10 k Ω

50 k Ω

100 $k\Omega$

3: MCP43X1 only.

Potentiometer

Non-linearity

Differential

Non-linearity

load = 30 pF)

Bandwidth -3 dB

(See Figure 2-92,

Potentiometer

Integral

4: MCP43X2 only, includes V_{WZSE} and V_{WFSE} .

INL

DNL

BW

- 5: Resistor terminals A, W and B's polarity with respect to each other is not restricted.
- 6: This specification by design.
- 7: Non-linearity is affected by wiper resistance (R_W), which changes significantly over voltage and temperature.
- 8: The MCP43X1 is externally connected to match the configurations of the MCP43X2, and then tested.
- **9:** POR/BOR is not rate dependent.
- **10:** Supply current is independent of current through the resistor network.

		Standard Operating Conditions (unless otherwise specified) Operating Temperature $-40^{\circ}\text{C} \le T_{A} \le +125^{\circ}\text{C}$ (extended)									
DC Characteristics	S	All parameters apply across the specified operating ranges unless noted. V_{DD} = +2.7V to 5.5V, 5 k Ω , 10 k Ω , 50 k Ω , 100 k Ω devices. Typical specifications represent values for V_{DD} = 5.5V, T_A = +25°C.									
Parameters	Sym	Min	Тур	Max	Units	Conditions					
Rheostat Integral	R-INL	-1.5	±0.5	+1.5	LSb	5 kΩ	8-bit	5.5V, I _W = 900 μA			
Non-linearity MCP43X1		-8.25	+4.5	+8.25	LSb			3.0V, I _W = 480 μA (Note 7)			
(Note 4, Note 8)			Section	on 2.0				1.8V, I _W = 190 µA			
MCP43X2 devices only (Note 4)		-1.125	±0.5	+1.125	LSb		7-bit	5.5V, I _W = 900 μA			
Offiny (Note 4)		-6.0	+4.5	+6.0	LSb			3.0V, I _W = 480 μA (Note 7)			
			Section	on 2.0				1.8V, I _W = 190 μA			
		-1.5	±0.5	+1.5	LSb	10 kΩ	8-bit	5.5V, I _W = 450 μA			
		-5.5	+2.5	+5.5	LSb			3.0V, I _W = 240 μA (Note 7)			
			Section	on 2.0				1.8V, I _W = 150 μA			
		-1.125	±0.5	+1.125	LSb		7-bit	5.5V, I _W = 450 μA			
		-4.0	+2.5	+4.0	LSb			3.0V, I _W = 240 μA (Note 7)			
			Section	on 2.0				1.8V, I _W = 150 μA			
		-1.5	±0.5	+1.5	LSb	50 kΩ	8-bit	5.5V, I _W = 90 μA			
		-2.0	+1	+2.0	LSb			3.0V, I _W = 48 μA (Note 7)			
			Section	on 2.0				1.8V, I _W = 30 μA			
		-1.125	±0.5	+1.125	LSb		7-bit	5.5V, I _W = 90 μA			
		-1.5	+1	+1.5	LSb			3.0V, I _W = 48 μA (Note 7)			
			Section	on 2.0				1.8V, I _W = 30 μA			
		-1.0	±0.5	+1.0	LSb	100 kΩ	8-bit	5.5V, I _W = 45 μA			
		-1.5	+0.25	+1.5	LSb			3.0V, I _W = 24 μA (Note 7)			
			Section	on 2.0				1.8V, I _W = 15 μA			
		-0.8	±0.5	+0.8	LSb		7-bit	5.5V, I _W = 45 μA			
		-1.125	+0.25	+1.125	LSb			3.0V, I _W = 24 μA (Note 7)			
		a tha rasia		on 2.0	:! A 4- 4			1.8V, I _W = 15 μA			

- Note 1: Resistance is defined as the resistance between terminal A to terminal B.
 - 2: INL and DNL are measured at V_W with $V_A = V_{DD}$ and $V_B = V_{SS}$.
 - 3: MCP43X1 only.
 - 4: MCP43X2 only, includes V_{WZSE} and V_{WFSE} .
 - **5**: Resistor terminals A, W and B's polarity with respect to each other is not restricted.
 - 6: This specification by design.
 - 7: Non-linearity is affected by wiper resistance (R_W), which changes significantly over voltage and temperature.
 - 8: The MCP43X1 is externally connected to match the configurations of the MCP43X2, and then tested.
 - 9: POR/BOR is not rate dependent.
 - 10: Supply current is independent of current through the resistor network.

	Standard Operating Conditions (unless otherwise specified) Operating Temperature $-40^{\circ}\text{C} \le \text{T}_{\text{A}} \le +125^{\circ}\text{C}$ (extended)									
DC Characteristics	3	All parameters apply across the specified operating ranges unless noted. V_{DD} = +2.7V to 5.5V, 5 k Ω , 10 k Ω , 50 k Ω , 100 k Ω devices. Typical specifications represent values for V_{DD} = 5.5V, T_A = +25°C.								
Parameters	Sym	Min	Тур	Max	Units		Conditions			
Rheostat	R-DNL	-0.5	±0.25	+0.5	LSb	5 kΩ	8-bit	5.5V, I _W = 900 μA		
Differential Non-linearity MCP43X1 (Note 4, Note 8)		-1.0	+0.5	+1.0	LSb			3.0V, I _W = 480 μA (Note 7)		
			Section	on 2.0				1.8V, I _W = 190 μA		
MCP43X2 devices		-0.375	±0.25	+0.375	LSb		7-bit	5.5V, I _W = 900 μA		
only (Note 4)		-0.75	+0.5	+0.75	LSb			3.0V, I _W = 480 μA (Note 7)		
			Section	on 2.0				1.8V, I _W = 190 μA		
		-0.5	±0.25	+0.5	LSb	10 kΩ	8-bit	5.5V, I _W = 450 μA		
		-1.0	+0.25	+1.0	LSb			3.0V, I _W = 240 μA (Note 7)		
			Section	on 2.0				1.8V, I _W = 150 μA		
		-0.375	±0.25	+0.375	LSb		7-bit	5.5V, I _W = 450 μA		
		-0.75	+0.5	+0.75	LSb			3.0V, I _W = 240 μA (Note 7)		
			Section	on 2.0				1.8V, I _W = 150 μA		
		-0.5	±0.25	+0.5	LSb	50 kΩ	8-bit	5.5V, I _W = 90 μA		
		-0.5	±0.25	+0.5	LSb			3.0V, I _W = 48 μA (Note 7)		
			Section	on 2.0				1.8V, I _W = 30 μA		
		-0.375	±0.25	+0.375	LSb		7-bit	5.5V, I _W = 90 μA		
		-0.375	±0.25	+0.375	LSb			3.0V, I _W = 48 μA (Note 7)		
			Section	on 2.0				1.8V, I _W = 30 μA		
		-0.5	±0.25	+0.5	LSb	100 kΩ	8-bit	5.5V, I _W = 45 μA		
		-0.5	±0.25	+0.5	LSb			3.0V, I _W = 24 μA (Note 7)		
			Section	on 2.0				1.8V, I _W = 15 μA		
		-0.375	±0.25	+0.375	LSb		7-bit	5.5V, I _W = 45 μA		
		-0.375	±0.25	+0.375	LSb			3.0V, I _W = 24 μA (Note 7)		
	:- defined -		Section	on 2.0	:! A 4- 4			1.8V, I _W = 30 μA		

- Note 1: Resistance is defined as the resistance between terminal A to terminal B.
 - 2: INL and DNL are measured at V_W with $V_A = V_{DD}$ and $V_B = V_{SS}$.
 - 3: MCP43X1 only.
 - 4: MCP43X2 only, includes V_{WZSE} and V_{WFSE} .
 - **5:** Resistor terminals A, W and B's polarity with respect to each other is not restricted.
 - 6: This specification by design.
 - 7: Non-linearity is affected by wiper resistance (R_W), which changes significantly over voltage and temperature.
 - 8: The MCP43X1 is externally connected to match the configurations of the MCP43X2, and then tested.
 - **9:** POR/BOR is not rate dependent.
 - 10: Supply current is independent of current through the resistor network.

DC Characteristics	3	Standard Operating Conditions (unless otherwise specified) Operating Temperature $-40^{\circ}\text{C} \leq \text{T}_{\text{A}} \leq +125^{\circ}\text{C} \text{ (extended)}$ All parameters apply across the specified operating ranges unless noted. $V_{DD} = +2.7\text{V to } 5.5\text{V}, 5 \text{ k}\Omega, 10 \text{ k}\Omega, 50 \text{ k}\Omega, 100 \text{ k}\Omega \text{ devices.}$ Typical specifications represent values for $V_{DD} = 5.5\text{V}, T_{\text{A}} = +25^{\circ}\text{C}$.								
Parameters	Sym	Min	Тур	Max	Units	Conditions				
Capacitance (P _A)	C_AW	_	75	1	pF	f =1 MHz, Code = Full Scale				
Capacitance (P _w)	C_W		120		pF	f =1 MHz, Code = Full Scale				
Capacitance (P _B)	C_{BW}	_	75		pF	f =1 MHz, Code = Full Scale				
Digital Inputs/Outputs (CS, SDI, SDO, SCK, WP, RESET)										
Schmitt Trigger High Input Threshold	V _{IH}	0.45 V _D	_	_	V	$2.7V \le V_{DD} \le 5.5V$ (Allows 2.7V Digital V_{DD} with 5V Analog V_{DD})				
		0.5 V _{DD}	_	_	V	$1.8V \le V_{DD} \le 2.7V$				
Schmitt Trigger Low Input Threshold	V _{IL}	_	_	0.2V _{DD}	>					
Hysteresis of Schmitt Trigger Inputs	V _{HYS}	_	0.1V _{DD}	_	>					
High Voltage Input Entry Voltage	V _{IHH}	8.5	_	12.5 ⁽⁶⁾	V					
High Voltage Input Exit Voltage	V_{IHH}	_	_	V _{DD} + 0.8V	V					
High Voltage Limit	V_{MAX}	_	_	12.5 ⁽⁶⁾	V	Pin can tolerate V _{MAX} or less.				
Output Low	V _{OL}	V _{SS}	_	0.3V _{DD}	V	I _{OL} = 5 mA, V _{DD} = 5.5V				
Voltage (SDO)		V _{SS}	_	0.3V _{DD}	V	I _{OL} = 1 mA, V _{DD} = 1.8V				
Output High	V _{OH}	0.7V _{DD}	_	V_{DD}	V	I_{OH} = -2.5 mA, V_{DD} = 5.5V				
Voltage (SDO)		0.7V _{DD}	_	V_{DD}	V	$I_{OL} = -1 \text{ mA}, V_{DD} = 1.8V$				

- Note 1: Resistance is defined as the resistance between terminal A to terminal B.
 - 2: INL and DNL are measured at V_W with $V_A = V_{DD}$ and $V_B = V_{SS}$.
 - 3: MCP43X1 only.
 - 4: MCP43X2 only, includes V_{WZSE} and V_{WFSE} .
 - **5**: Resistor terminals A, W and B's polarity with respect to each other is not restricted.
 - **6:** This specification by design.
 - **7:** Non-linearity is affected by wiper resistance (R_W) , which changes significantly over voltage and temperature.
 - 8: The MCP43X1 is externally connected to match the configurations of the MCP43X2, and then tested.
 - 9: POR/BOR is not rate dependent.
 - 10: Supply current is independent of current through the resistor network.

			d Operatir g Tempera	•		ess otherwis $T_A \le +125^{\circ}C$				
DC Characteristic	s	All parameters apply across the specified operating ranges unless noted. V_{DD} = +2.7V to 5.5V, 5 k Ω , 10 k Ω , 50 k Ω , 100 k Ω devices. Typical specifications represent values for V_{DD} = 5.5V, T_A = +25°C.								
Parameters	Sym	Min	Тур	Max	Units		Conditions			
Weak Pull-up Current	I _{PU}	_	_	1.75	mA		$_{O}$ pull-up, V_{IHH} pull-down, $V_{\overline{CS}}$ = 12.5V			
			170	_	μA	CS pin, V _{DE}) = 5.5V, V _{CS} = 3V			
CS Pull-up/ Pull-down Resistance	R _{CS}	_	16	_	kΩ	V _{DD} = 5.5V,	V _{CS} = 3V			
RESET Pull-up Resistance	R _{RESET}	_	16		kΩ	V _{DD} = 5.5V,	V _{RESET} = 0V			
Input Leakage Current	I _{IL}	-1	_	1	μΑ	$V_{IN} = V_{DD}$ (all pins) and $V_{IN} = V_{SS}$ (all pins except RESET)				
Pin Capacitance	C _{IN} , C _{OUT}	_	10	_	pF	f _C = 20 MHz	<u>'</u>			
RAM (Wiper, TCOI	N) Value									
Value Range	N	0h	_	1FFh	hex	8-bit device				
		0h	_	1FFh	hex	7-bit device				
TCON POR/BOR Setting			1FF		hex	All terminals	connected			
Wiper POR/BOR	N		080h		hex	8-bit				
Setting			040h		hex	7-bit				
Power Requireme	nts									
Power Supply Sensitivity	PSS		0.0015	0.0035	%/%	8-bit	V _{DD} = 2.7V to 5.5V, V _A = 2.7V, Code = 80h			
(MCP43X1)		_	0.0015	0.0035	%/%	7-bit	$V_{DD} = 2.7V \text{ to } 5.5V,$ $V_{A} = 2.7V, \text{ Code} = 40h$			

- Note 1: Resistance is defined as the resistance between terminal A to terminal B.
 - 2: INL and DNL are measured at V_W with $V_A = V_{DD}$ and $V_B = V_{SS}$.
 - 3: MCP43X1 only.
 - 4: MCP43X2 only, includes V_{WZSE} and V_{WFSE} .
 - 5: Resistor terminals A, W and B's polarity with respect to each other is not restricted.
 - **6:** This specification by design.
 - **7:** Non-linearity is affected by wiper resistance (R_W), which changes significantly over voltage and temperature.
 - 8: The MCP43X1 is externally connected to match the configurations of the MCP43X2, and then tested.
 - 9: POR/BOR is not rate dependent.
 - **10:** Supply current is independent of current through the resistor network.

1.1 SPI Mode Timing Waveforms and Requirements

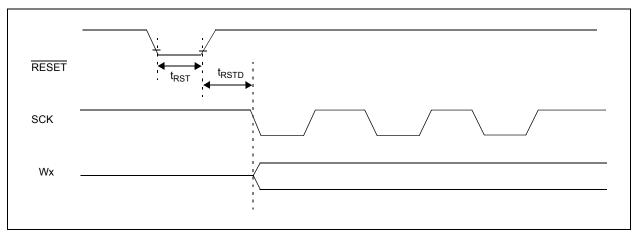


FIGURE 1-1: Reset Waveforms.

TABLE 1-1: RESET TIMING

		Standard Operating Conditions (unless otherwise specified) Operating Temperature $-40^{\circ}\text{C} \le T_{\text{A}} \le +125^{\circ}\text{C}$ (extended)									
Timing Characteristic	s	All parameters apply across the specified operating ranges unless noted. V_{DD} = +2.7V to 5.5V, 5 k Ω , 10 k Ω , 50 k Ω , 100 k Ω devices. Typical specifications represent values for V_{DD} = 5.5V, T_A = +25°C.									
Parameters	Sym	Min	Min Typ Max Units Conditions								
RESET pulse width	t _{RST}	50	_	_	ns						
RESET rising edge normal mode (Wiper driving and SPI interface operational)	t _{RSTD}	_	_	20	ns						

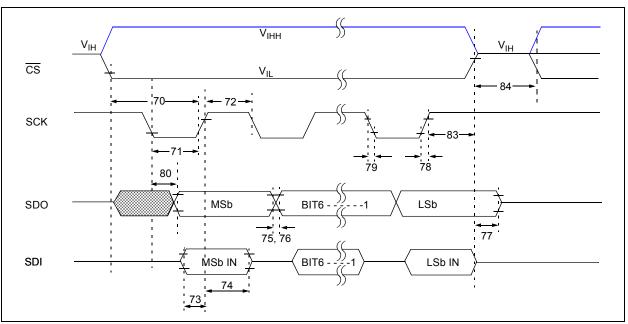


FIGURE 1-2: SPI Timing Waveform (Mode = 11).

TABLE 1-2: SPI REQUIREMENTS (MODE = 11)

#	Characteristic	Symbol	Min	Max	Units	Conditions
	SCK Input Frequency	F _{SCK}	_	10	MHz	V _{DD} = 2.7V to 5.5V
			_	1	MHz	V_{DD} = 1.8V to 2.7V
70	CS Active (V _{IL} or V _{IHH}) to SCK↑ input	TcsA2scH	60	_	ns	
71	SCK input high time	TscH	45	_	ns	V_{DD} = 2.7V to 5.5V
			500	_	ns	V_{DD} = 1.8V to 2.7V
72	SCK input low time	TscL	45	_	ns	V_{DD} = 2.7V to 5.5V
			500	_	ns	V_{DD} = 1.8V to 2.7V
73	Setup time of SDI input to SCK↑ edge	TDIV2scH	10	_	ns	V_{DD} = 2.7V to 5.5V
			20	_	ns	V_{DD} = 1.8V to 2.7V
74	Hold time of SDI input from SCK↑ edge	TscH2DIL	20	_	ns	
77	CS Inactive (V _{IH}) to SDO output high-impedance	TcsH2DoZ	_	50	ns	Note 1
80	SDO data output valid after SCK↓ edge	TscL2DOV	_	70	ns	V_{DD} = 2.7V to 5.5V
				170	ns	V_{DD} = 1.8V to 2.7V
83	CS Inactive (V _{IH}) after SCK↑ edge	TscH2csI	100	_	ns	V _{DD} = 2.7V to 5.5V
			1		ms	V_{DD} = 1.8V to 2.7V
84	Hold time of $\overline{\text{CS}}$ Inactive (V _{IH}) to $\overline{\text{CS}}$ Active (V _{IL} or V _{IHH})	TcsA2csI	50	_	ns	

Note 1: This specification by design.

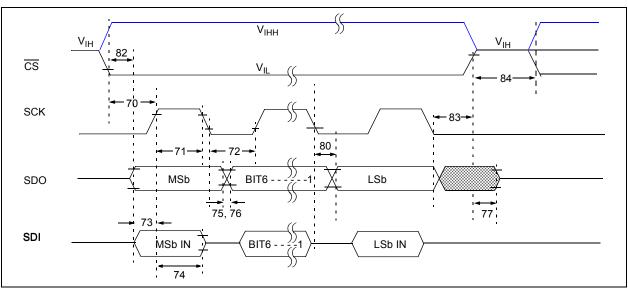


FIGURE 1-3: SPI Timing Waveform (Mode = 00).

TABLE 1-3: SPI REQUIREMENTS (MODE = 00)

#	Characteristic	Symbol	Min	Max	Units	Conditions
	SCK Input Frequency	F _{SCK}	_	10	MHz	V _{DD} = 2.7V to 5.5V
			_	1	MHz	V _{DD} = 1.8V to 2.7V
70	CS Active (V _{IL} or V _{IHH}) to SCK↑ input	TcsA2scH	60	_	ns	
71	SCK input high time	TscH	45	_	ns	$V_{DD} = 2.7V \text{ to } 5.5V$
			500	_	ns	V_{DD} = 1.8V to 2.7V
72	SCK input low time	TscL	45	_	ns	$V_{DD} = 2.7V \text{ to } 5.5V$
			500	_	ns	V_{DD} = 1.8V to 2.7V
73	Setup time of SDI input to SCK↑ edge	TDIV2scH	10	_	ns	$V_{DD} = 2.7V \text{ to } 5.5V$
			20	_	ns	V_{DD} = 1.8V to 2.7V
74	Hold time of SDI input from SCK↑ edge	TscH2DIL	20	_	ns	
77	CS Inactive (V _{IH}) to SDO output high-impedance	TcsH2DoZ	_	50	ns	Note 1
80	SDO data output valid after SCK↓ edge	TscL2DOV	_	70	ns	$V_{DD} = 2.7V \text{ to } 5.5V$
				170	ns	V_{DD} = 1.8V to 2.7V
82	SDO data output valid after CS Active (V _{IL} or V _{IHH})	TssL2doV	_	85	ns	
83	CS Inactive (V _{IH}) after SCK↓ edge	TscH2csl	100	_	ns	V _{DD} = 2.7V to 5.5V
			1		ms	V _{DD} = 1.8V to 2.7V
84	Hold time of $\overline{\text{CS}}$ Inactive (V _{IH}) to $\overline{\text{CS}}$ Active (V _{IL} or V _{IHH})	TcsA2csI	50	_	ns	

Note 1: This specification by design.

TEMPERATURE CHARACTERISTICS

Electrical Specifications: Unless otherwise indicated, V_{DD} = +2.7V to +5.5V, V_{SS} = GND.										
Parameters	Sym	Min	Тур	Max	Units	Conditions				
Temperature Ranges										
Specified Temperature Range	T _A	-40	_	+125	°C					
Operating Temperature Range	T _A	-40	_	+125	°C					
Storage Temperature Range	T _A	-65	_	+150	°C					
Thermal Package Resistances										
Thermal Resistance, 14L-TSSOP	θ_{JA}	_	100	_	°C/W					
Thermal Resistance, 20L-QFN	$\theta_{\sf JA}$		43	_	°C/W					
Thermal Resistance, 20L-TSSOP	θ_{JA}	_	90	_	°C/W					

MCP433X/435X

NOTES:

2.0 TYPICAL PERFORMANCE CURVES

Note: The graphs and tables provided following this note are a statistical summary based on a limited number of samples and are provided for informational purposes only. The performance characteristics listed herein are not tested or guaranteed. In some graphs or tables, the data presented may be outside the specified operating range (e.g., outside specified power supply range) and therefore outside the warranted range.

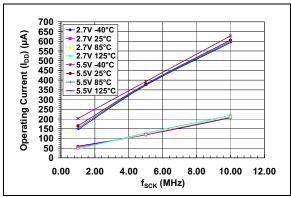


FIGURE 2-1: Device Current (I_{DD}) vs. SPI Frequency (f_{SCK}) and Ambient Temperature (V_{DD} = 2.7V and 5.5V).

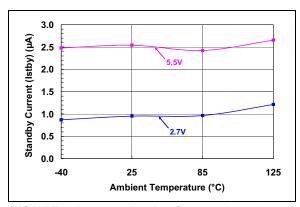


FIGURE 2-2: Device Current (I_{SHDN}) and V_{DD} . ($\overline{CS} = V_{DD}$) vs. Ambient Temperature.

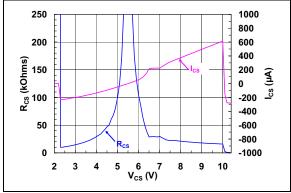


FIGURE 2-3: \overline{CS} Pull-up/Pull-down Resistance ($R_{\overline{CS}}$) and Current ($I_{\overline{CS}}$) vs. \overline{CS} Input Voltage ($V_{\overline{CS}}$) (V_{DD} = 5.5V).

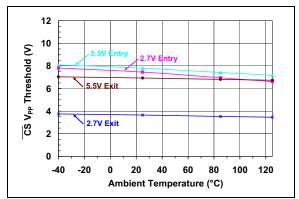


FIGURE 2-4: $\overline{\text{CS}}$ High Input Entry/Exit Threshold vs. Ambient Temperature and V_{DD} .

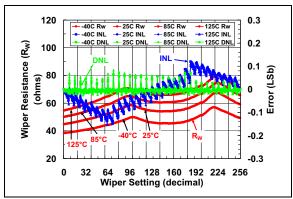


FIGURE 2-5: $5 \text{ k}\Omega \text{ Pot Mode} - R_W (\Omega)$, INL (LSb), DNL (LSb) vs. Wiper Setting and Ambient Temperature ($V_{DD} = 5.5V$).

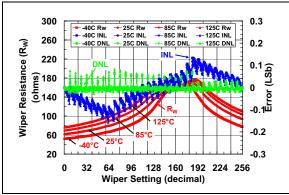


FIGURE 2-6: 5 $k\Omega$ Pot Mode – R_W (Ω), INL (LSb), DNL (LSb) vs. Wiper Setting and Ambient Temperature (V_{DD} = 3.0V).

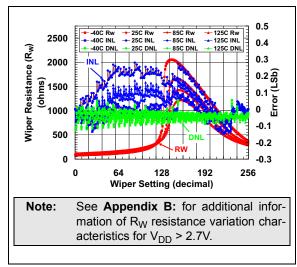


FIGURE 2-7: 5 $k\Omega$ Pot Mode – R_W (Ω), INL (LSb), DNL (LSb) vs. Wiper Setting and Ambient Temperature (V_{DD} = 1.8V).

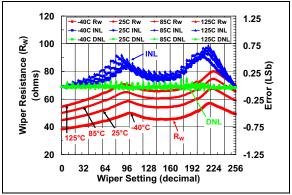


FIGURE 2-8: $5 \text{ k}\Omega$ Rheo Mode $- R_W (\Omega)$, INL (LSb), DNL (LSb) vs. Wiper Setting and Ambient Temperature ($V_{DD} = 5.5V$, $I_W = 900 \mu\text{A}$).

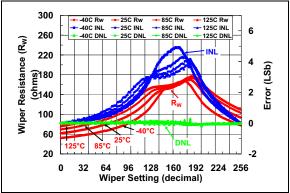


FIGURE 2-9: 5 kΩ Rheo Mode – R_W (Ω), INL (LSb), DNL (LSb) vs. Wiper Setting and Ambient Temperature (V_{DD} = 3.0V, I_W = 480 μA).

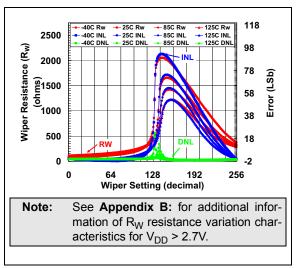


FIGURE 2-10: 5 $k\Omega$ Rheo Mode – R_W (Ω), INL (LSb), DNL (LSb) vs. Wiper Setting and Ambient Temperature (V_{DD} = 1.8V, I_W = 260 μ A).

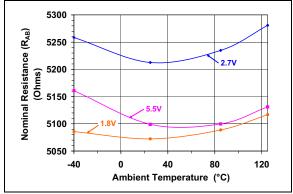


FIGURE 2-11: 5 $k\Omega$ – Nominal Resistance (R_{AB}) (Ω) vs. Ambient Temperature and V_{DD} .

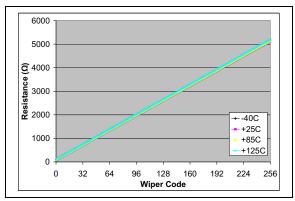


FIGURE 2-12: $5 k\Omega - R_{WB} (\Omega)$ vs. Wiper Setting and Ambient Temperature $(V_{DD} = 5.5V, I_W = 190 \ \mu\text{A})$.

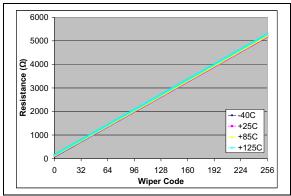


FIGURE 2-13: $5 \ k\Omega - R_{WB} \ (\Omega) \ vs.$ Wiper Setting and Ambient Temperature $(V_{DD} = 3.0V, I_W = 190 \ \mu A)$.

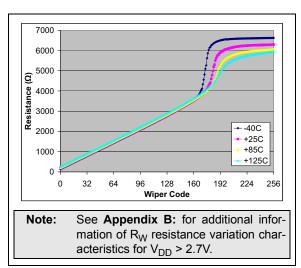


FIGURE 2-14: $5 k\Omega - R_{WB} (\Omega)$ vs. Wiper Setting and Ambient Temperature $(V_{DD} = 1.8V, I_W = 190 \ \mu A)$.

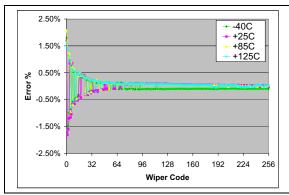


FIGURE 2-15: $5 \, k\Omega$ – Worst Case R_{BW} from Average R_{BW} (R_{BW0} - R_{BW3}) Error (%) vs. Wiper Setting and Temperature (V_{DD} = 5.5V, I_W = 190 μ A).

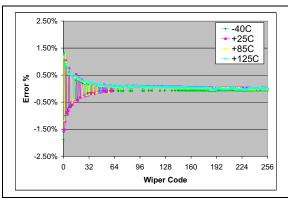


FIGURE 2-16: $5 \, k\Omega$ – Worst Case R_{BW} from Average R_{BW} (R_{BW0} - R_{BW3}) Error (%) vs. Wiper Setting and Temperature (V_{DD} = 3.0V, I_W = 190 μ A).

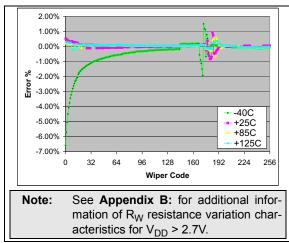


FIGURE 2-17: $5 \, k\Omega$ – Worst Case R_{BW} from Average R_{BW} (R_{BW0} - R_{BW3}) Error (%) vs. Wiper Setting and Temperature (V_{DD} = 1.8V, I_W = 190 μ A).

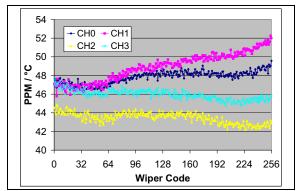


FIGURE 2-18: 5 kΩ – R_{WB} PPM/°C vs. Wiper Setting. ($R_{BW(code=n,\ 125^{\circ}C)}$ - $R_{BW(code=n,\ -40^{\circ}C)}$)/ $R_{BW(code}$ = 256, 25°C)/165°C * 1,000,000) (V_{DD} = 5.5V, I_{W} = 190 μA).

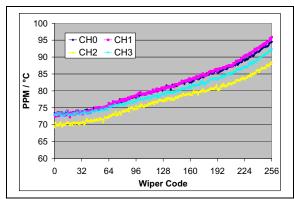


FIGURE 2-19: 5 kΩ – R_{WB} PPM/°C vs. Wiper Setting. ($R_{BW(code=n,\ 125^{\circ}C)}$ - $R_{BW(code=n,\ -40^{\circ}C)}$)/ $R_{BW(code=\ 256,\ 25^{\circ}C)}$ /165°C * 1,000,000) (V_{DD} = 3.0V, I_{W} = 190 μA).

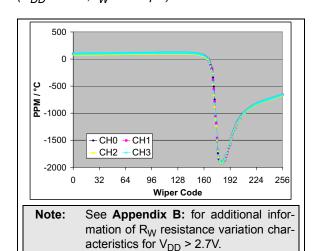


FIGURE 2-20: $5 \, k\Omega - R_{WB} \, PPM/^{\circ}C \, vs.$ Wiper Setting. $(R_{BW(code=n,\ 125^{\circ}C)}-R_{BW(code=n,\ -40^{\circ}C)})/R_{BW(code}=256,\ 25^{\circ}C)/165^{\circ}C * 1,000,000)$ $(V_{DD}=1.8V,\ I_{W}=190 \, \mu A).$

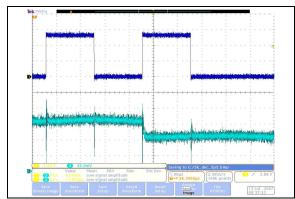


FIGURE 2-21: $5 k\Omega$ – Low-Voltage Decrement Wiper Settling Time (V_{DD} = 5.5V) (1 μ s/Div).

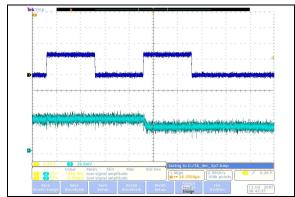


FIGURE 2-22: $5 \text{ k}\Omega$ – Low-Voltage Decrement Wiper Settling Time (V_{DD} = 2.7V) (1 μ s/Div).

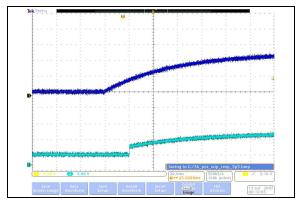


FIGURE 2-23: $5 k\Omega$ – Power-Up Wiper Response Time (20 ms/Div).

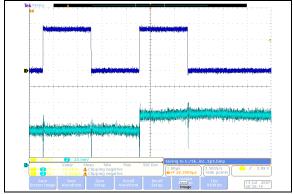


FIGURE 2-24: $5 \text{ k}\Omega$ – Low-Voltage Increment Wiper Settling Time (V_{DD} = 5.5V) (1 μ s/Div).

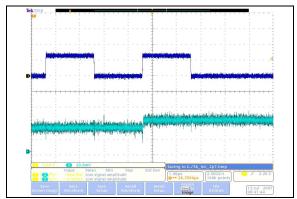


FIGURE 2-25: $5 k\Omega$ – Low-Voltage Increment Wiper Settling Time (V_{DD} = 2.7V) (1 μ s/Div).

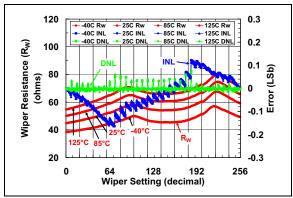


FIGURE 2-26: 10 $k\Omega$ Pot Mode – R_W (Ω), INL (LSb), DNL (LSb) vs. Wiper Setting and Ambient Temperature (V_{DD} = 5.5V).

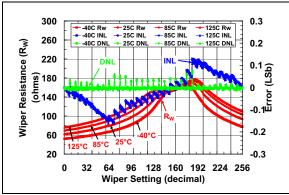


FIGURE 2-27: 10 $k\Omega$ Pot Mode – R_W (Ω), INL (LSb), DNL (LSb) vs. Wiper Setting and Ambient Temperature (V_{DD} = 3.0V).

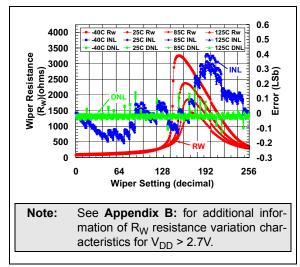


FIGURE 2-28: 10 $k\Omega$ Pot Mode – R_W (Ω), INL (LSb), DNL (LSb) vs. Wiper Setting and Ambient Temperature (V_{DD} = 1.8V).

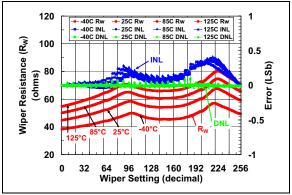


FIGURE 2-29: 10 kΩ Rheo Mode – R_W (Ω), INL (LSb), DNL (LSb) vs. Wiper Setting and Ambient Temperature (V_{DD} = 5.5V, I_W = 450 μA).

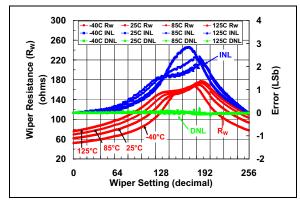


FIGURE 2-30: 10 kΩ Rheo Mode – R_W (Ω), INL (LSb), DNL (LSb) vs. Wiper Setting and Ambient Temperature (V_{DD} = 3.0V, I_W = 240 μA).

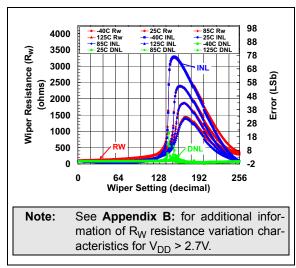


FIGURE 2-31: 10 k Ω Rheo Mode – $R_W(\Omega)$, INL (LSb), DNL (LSb) vs. Wiper Setting and Ambient Temperature (V_{DD} = 1.8V, I_W = 125 μ A).

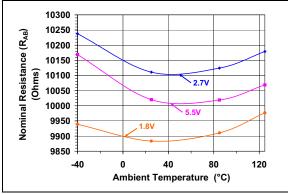


FIGURE 2-32: 10 $k\Omega$ – Nominal Resistance (R_{AB}) (Ω) vs. Ambient Temperature and V_{DD} .

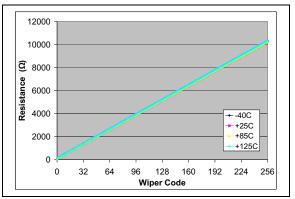


FIGURE 2-33: 10 k Ω – R_{WB} (Ω) vs. Wiper Setting and Ambient Temperature (V_{DD} = 5.5V, I_{W} = 150 μ A).

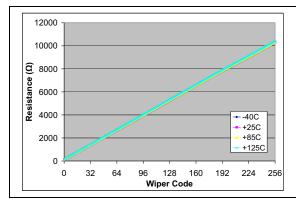


FIGURE 2-34: 10 kΩ – R_{WB} (Ω) vs. Wiper Setting and Ambient Temperature (V_{DD} = 3.0V, I_{W} = 150 μA).

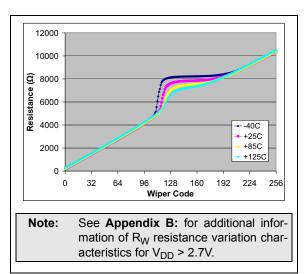


FIGURE 2-35: 10 $k\Omega$ – R_{WB} (Ω) vs. Wiper Setting and Ambient Temperature (V_{DD} = 1.8V, I_{W} = 150 μ A).

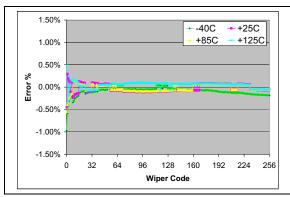


FIGURE 2-36: 10 $k\Omega$ – Worst Case R_{BW} from Average R_{BW} (R_{BW0} - R_{BW3}) Error (%) vs. Wiper Setting and Temperature (V_{DD} = 5.5V, I_W = 150 μ A).

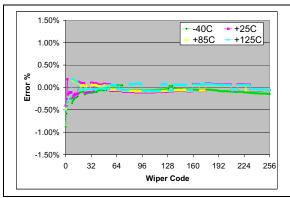


FIGURE 2-37: 10 $k\Omega$ – Worst Case R_{BW} from Average R_{BW} (R_{BW0} - R_{BW3}) Error (%) vs. Wiper Setting and Temperature (V_{DD} = 3.0V, I_W = 150 μ A).

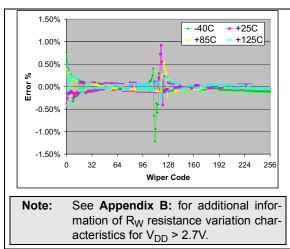


FIGURE 2-38: 10 kΩ – Worst Case R_{BW} from Average R_{BW} (R_{BW0} - R_{BW3}) Error (%) vs. Wiper Setting and Temperature (V_{DD} = 1.8V, I_W = 150 μA).

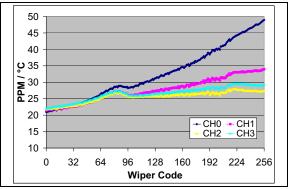


FIGURE 2-39: 10 kΩ – R_{WB} PPM/°C vs. Wiper Setting. ($R_{BW(code=n,\ 125^{\circ}C)}$ - $R_{BW(code=n,\ -40^{\circ}C)}$)/ $R_{BW(code=256,\ 25^{\circ}C)}$ /165°C * 1,000,000) ($V_{DD}=5.5V$, $I_{W}=150\ \mu A$).

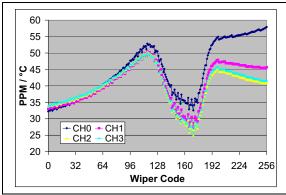


FIGURE 2-40: 10 kΩ – R_{WB} PPM/°C vs. Wiper Setting. (R_{BW(code=n, 125°C)}-R_{BW(code=n, -40°C)})/R_{BW(code} = 256, 25°C)</sub>/165°C * 1,000,000) (V_{DD} = 3.0V, I_W = 150 μA).

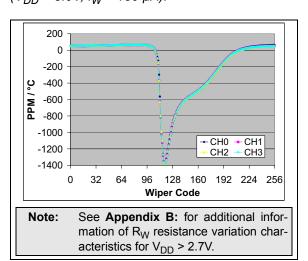


FIGURE 2-41: 10 kΩ – R_{WB} PPM/°C vs. Wiper Setting. ($R_{BW(code=n,\ 125^{\circ}C)}$ - $R_{BW(code=n,\ -40^{\circ}C)}$)/ $R_{BW(code=256,\ 25^{\circ}C)}$ /165°C * 1,000,000) ($V_{DD}=1.8V,\ I_{W}=150\ \mu A$).

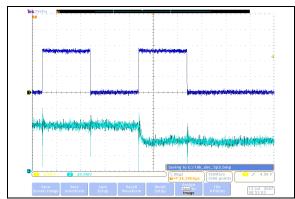


FIGURE 2-42: 10 kΩ – Low-Voltage Decrement Wiper Settling Time (V_{DD} = 5.5V) (1 μs/Div).

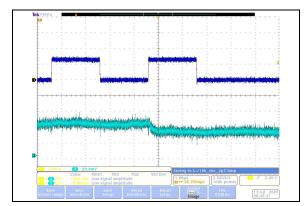


FIGURE 2-43: 10 k Ω – Low-Voltage Decrement Wiper Settling Time (V_{DD} = 2.7V) (1 μ s/Div).

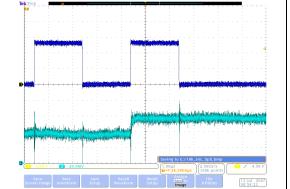


FIGURE 2-44: 10 k Ω – Low-Voltage Increment Wiper Settling Time (V_{DD} = 5.5V) (1 μ s/Div).

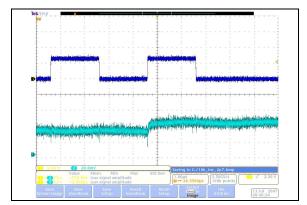


FIGURE 2-45: 10 k Ω – Low-Voltage Increment Wiper Settling Time (V_{DD} = 2.7V) (1 μ s/Div).